



## **EU DECLARATION OF CONFORMITY**

### ***RoHS Directive 2015/863(RoHS3)***

**Declaration Issue Date:** 05th January 2023

**Products Covered:** CCGM\*, CGM\*, CM\*, CS\*, CSL\*, CU02\*, CUC\*, CUTA02\*, DU01\*  
IMU011E, MNC\*, RMS\*, SCM\*, TES011C manufactured by EMUS  
UAB

Emus UAB product(s) and its sub-components, to the Company's knowledge and after information provided by material suppliers, are declaring not to contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls („PBB“), or polybrominated diphenyl ethers („PBDE“), bis(2-ethylhexyl) phthalate („DEHP“), butyl benzyl phthalate („BBP“), dibutyl phthalate („DBP“) and diisobutyl phthalate („DIBP“) above the indicated levels set forth in the current Commission Delegated Directive (EU) 2015/863 of 31 March 2015, amending Annex II to Directive 2011/65/EU.

**Exemptions provided by Emus product sub-component manufacturers:**

Annex III 7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g., piezo electronic devices, or in a glass or ceramic matrix compound

Annex III 7(a) Lead in high melting temperature type solders (i.e., lead-based alloys containing 85 % by weight or more lead)

Annex III 7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g., piezoelectric devices, or in a glass or ceramic matrix compound

Annex III 6(a)-I Lead as an alloying element in steel for machining purposes containing up to 0,35 % lead by weight and in batch hot dip galvanized steel components containing up to 0,2 % lead by weight

Annex III 6(b)-II Lead as an alloying element in aluminum for machining purposes with a lead content up to 0,4 % by weight

  
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Julius Jakas  
Procurement Manager

\* Including all product series indicating letters before asterisk are covered

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